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1-390262-2 Product Details

Have a Question?

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Quick Links

Check Pricing & Availability Search for Tooling Product Feature Selector

Contact Us About This Product





DIP Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Socket Style = Standard
 Through Hole Contact Termination Type

View all Features

- 2.54 mm Centerline Row-to-Row Spacing = 15.24 mm
- 28 Positions

TE Internal Number: 1-390262-2



View 3D PDF









Documentation & Additional Information

Product Drawings:

DIP SOCKET, .600 CENTER LINE LADDER STYLE (PDF, English)

Catalog Pages/Data Sheets:

Product Specifications:

Application Specifications:

Instruction Sheets:

CAD Files: (CAD Format & Compression Information) • 2D Drawing (DXF, Version M) • 3D Model (IGES, Version M)

- 3D Model (STEP, Version M)

List all Documents

Additional Information:

Related Products:

Tooling

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Socket Style = Standard • Profile = Standard
- Frame Style = Ladder
- Leg Style = Straight
- PCB Mount Angle = Horizontal

- Electrical Characteristics: Insulation Resistance (M Ω) = 10,000
 - Contact Resistance (mΩ) = 30

Termination Related Features:

• Termination Post Length (mm [in]) = 3.00 [0.118]

- Body Related Features:
 Centerline (mm [in]) = 2.54 [0.100]
 - Row-to-Row Spacing (mm [in]) = 15.24 [0.600]
 - Number of Positions = 28
 - Mount Style = Vertical

Contact Related Features:

- Contact Termination Type = Through Hole
- Contact Base Material = Phosphor Bronze • Contact Plating, Mating Area, Material = Tin
- Contact Style = Stamped + Formed
- Mating Contact Type = Dual Leaf

Configuration Related Features:
• Height Above PC Board (mm [in]) = 5.10 [0.200]

Industry Standards:

- ROHS/ELV Compliance = RoHS compliant, ELV compliant
 Lead Free Solder Processes = Wave solder capable to 240°C, Wave solder capable to 260°C, Wave solder capable to 265°C
- · RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:
• Temperature Range (°C) = -40 - +105

Packaging Related Features:

Other:

Brand = AMP

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